



Laboratoire d'Anecy-le-Vieux
de Physique des Particules



Readout and DAQ for Micromegas

Guillaume Vouters



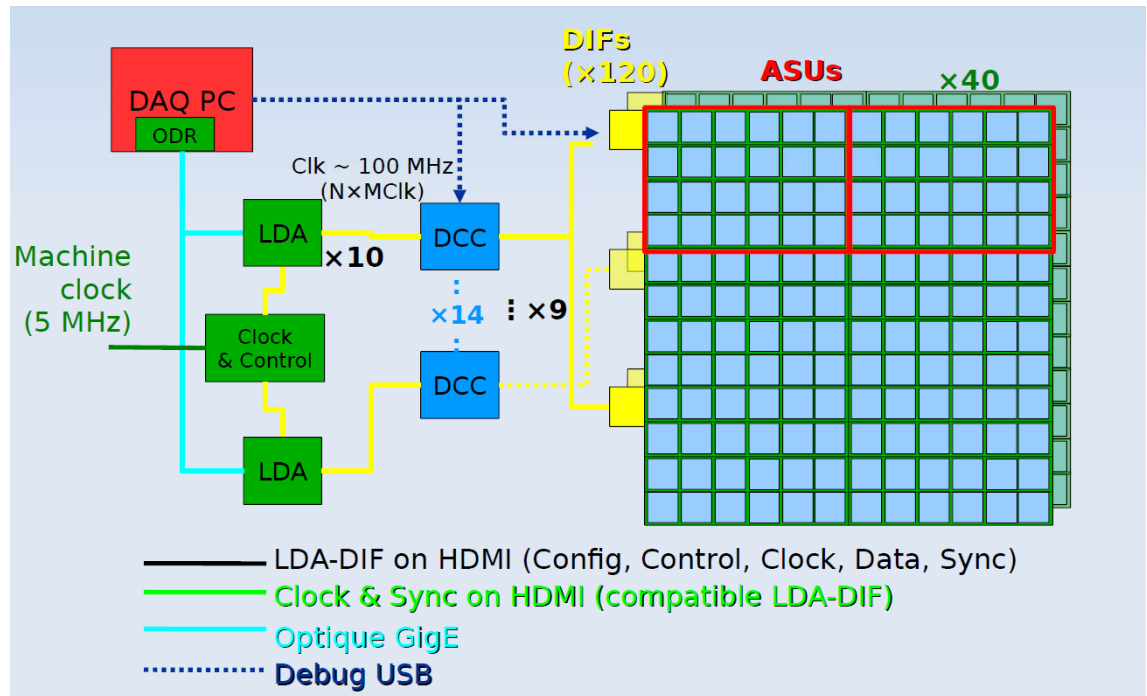
Plan

- **The HCAL Architecture**
- **ASUs developed at LAPP for MICROMEAS**
 - ASU 8x32 with HARDROC v.1
 - ASU 32x48 with HARDROC v.2 for m²
 - ASU 8x8 with DIRAC v.1/DIRAC v.2
- **DIF developments**
 - Firmware for ASICs
 - Firmware for the CALICE DAQ

The HCAL Architecture

One cubic meter technological prototype :

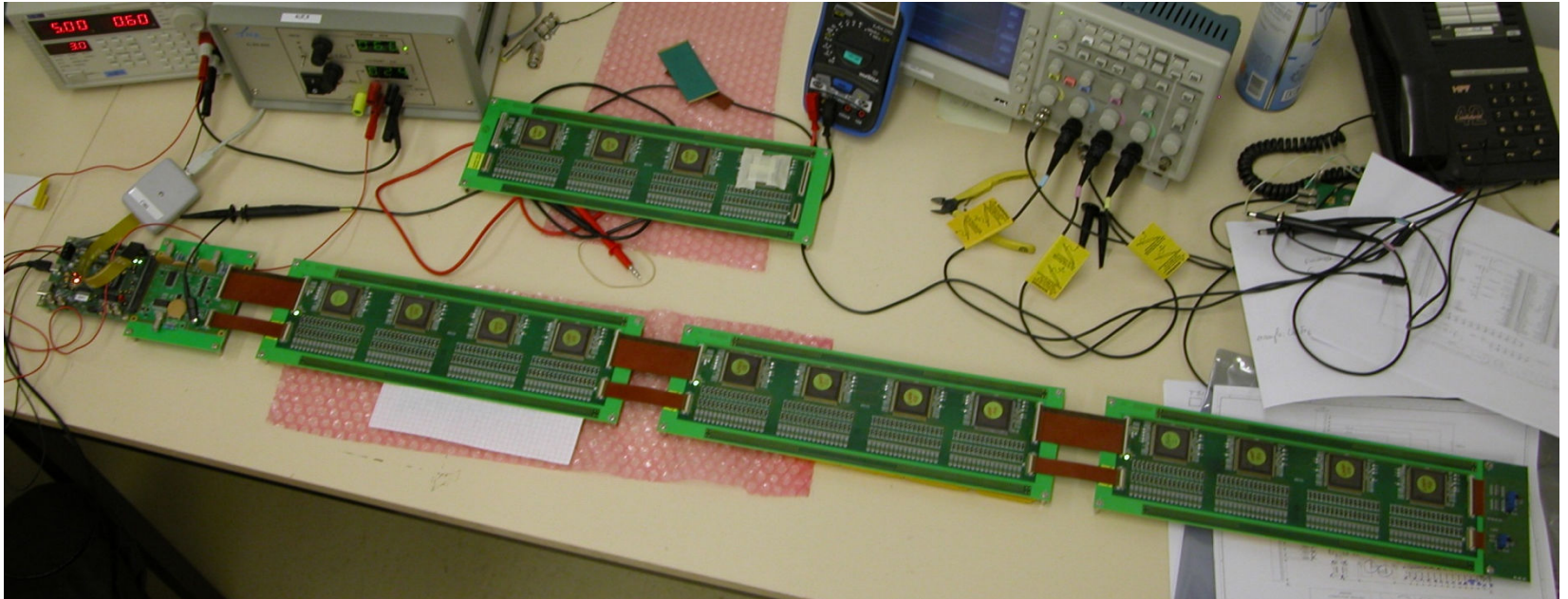
- 40 plans
- 400 000 channels
- “Digital” Readout :
3 thresholds
- Power pulsing



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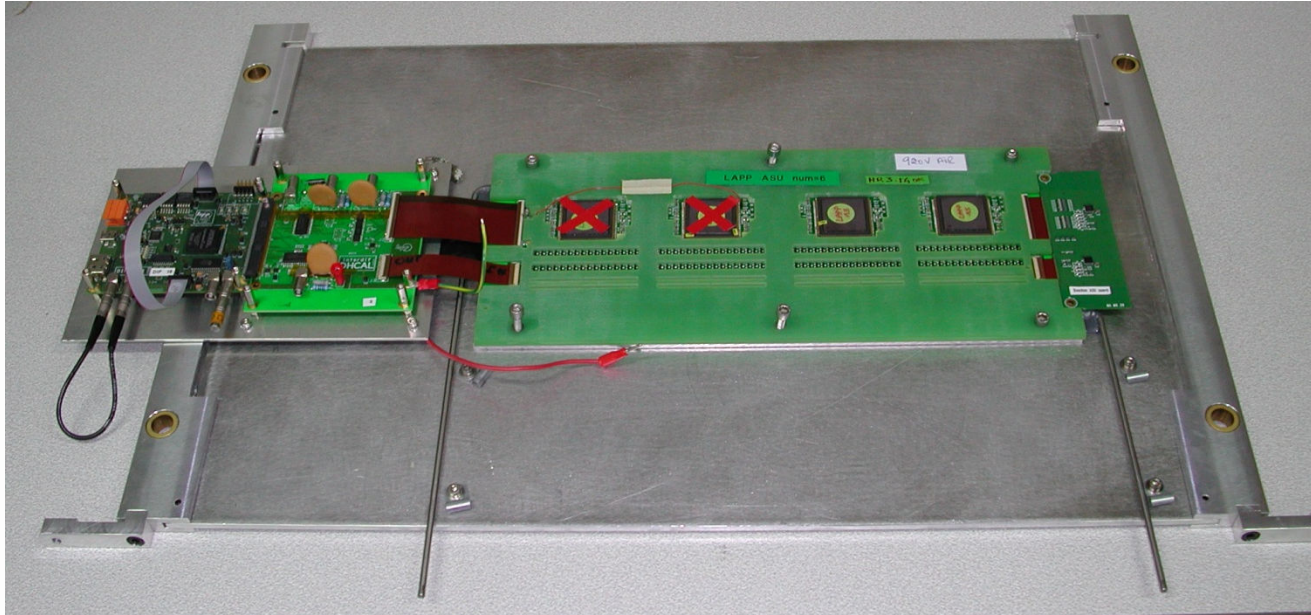
ASU 8x32 with HARDROC v.1



First we tried to communicate with our boards

→ We managed to control 12 HARDROCs v.1

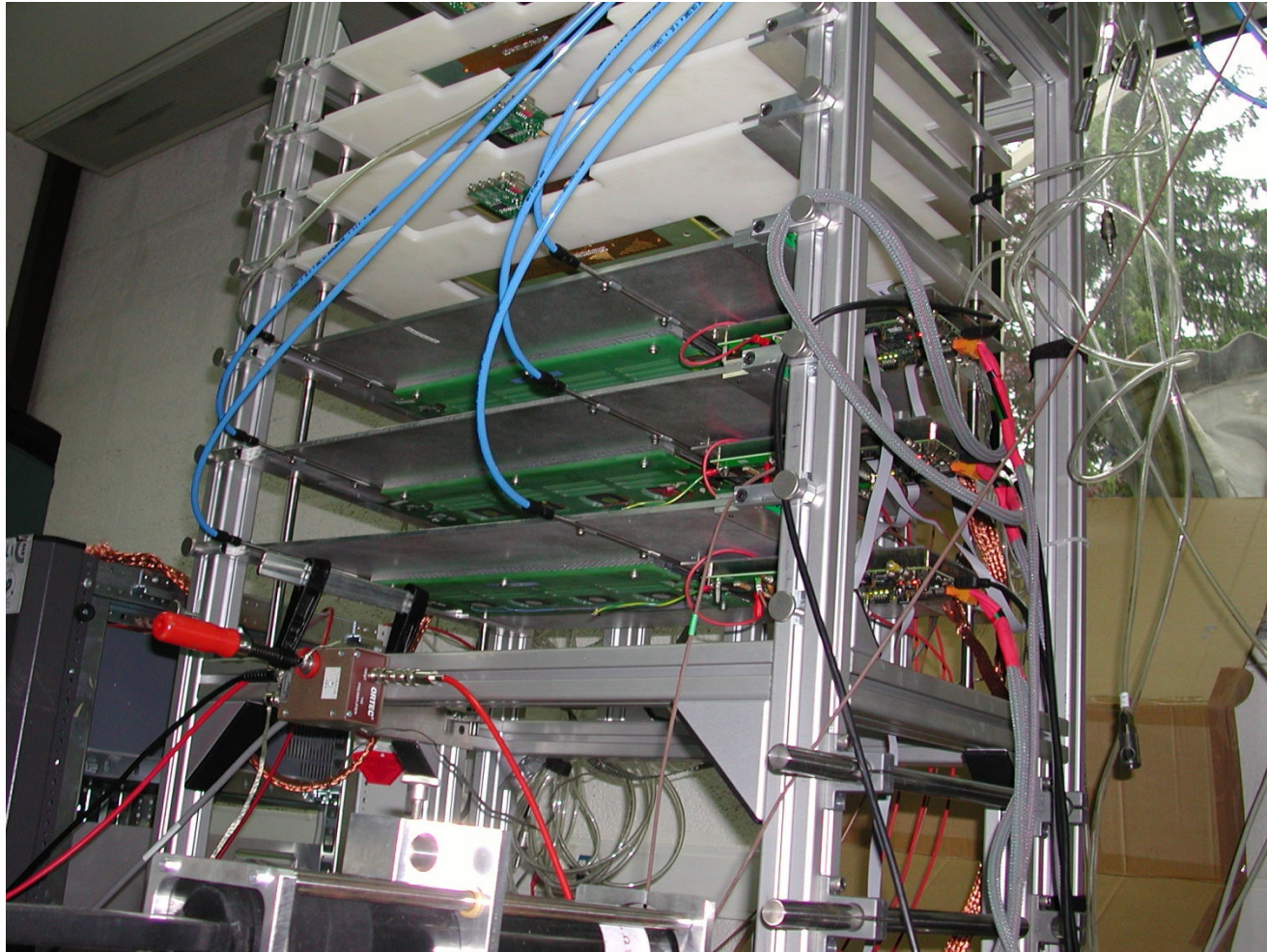
ASU 8x32 with HARDROC v.1



Then we built bulk MICROMEAS

→ We have now 4 detectors but there are only
11 HARDROCs v.1 still working

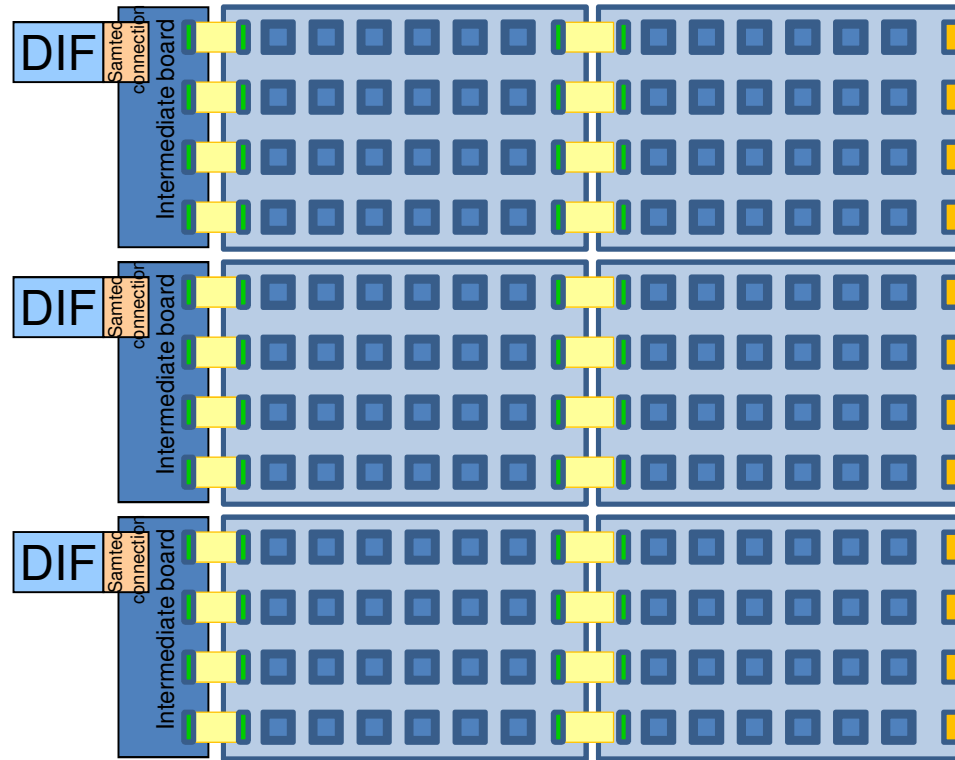
ASU 8x32 with HARDROC v.1



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Architecture of the m²



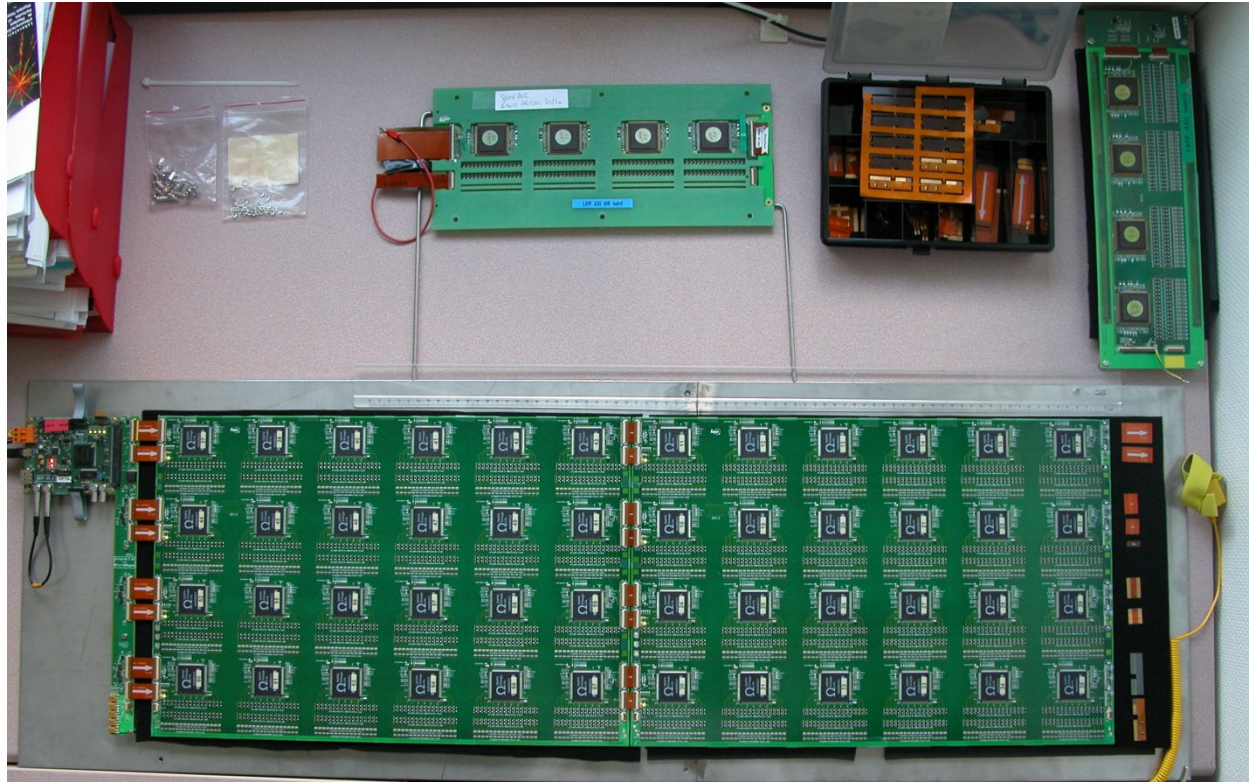
Flat Printed Circuit

ASIC chip (64 channels)

Hirose connector

Termination component

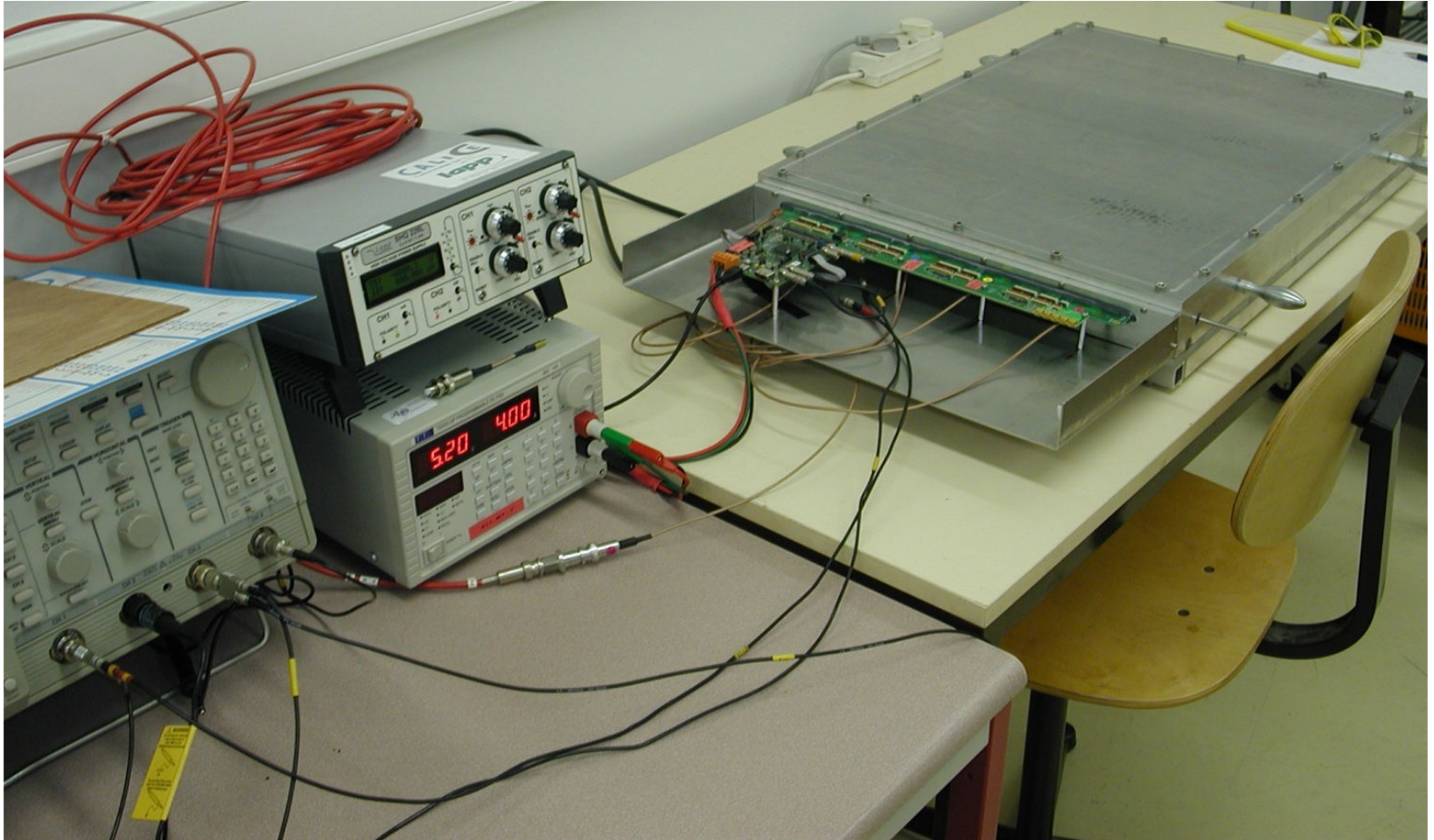
ASU 32x48 with HARDROC v.2



Here is a part of the square meter

→ We managed to control 48 HARDROCs v.2

Test Box for ASU 32x48



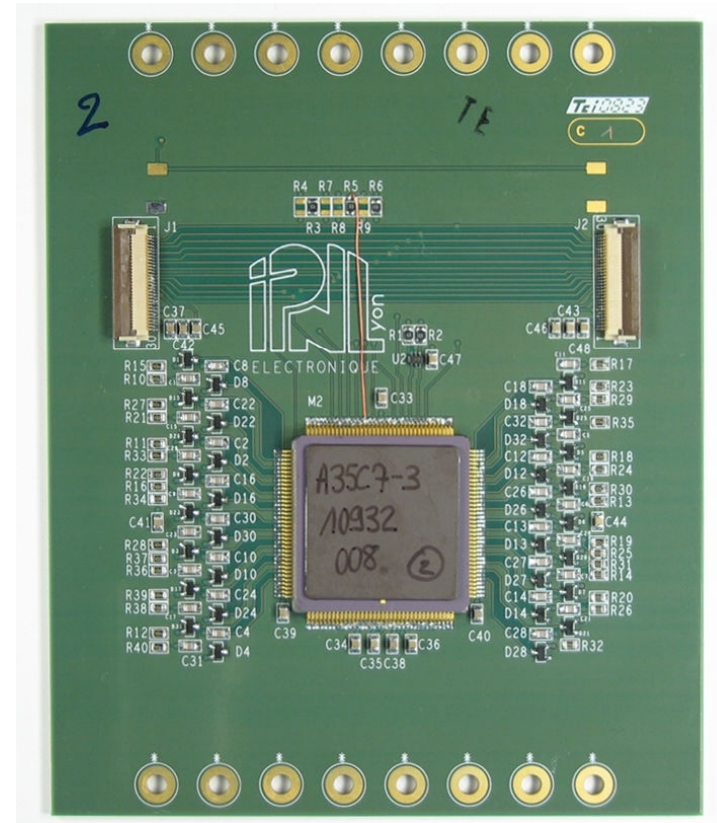
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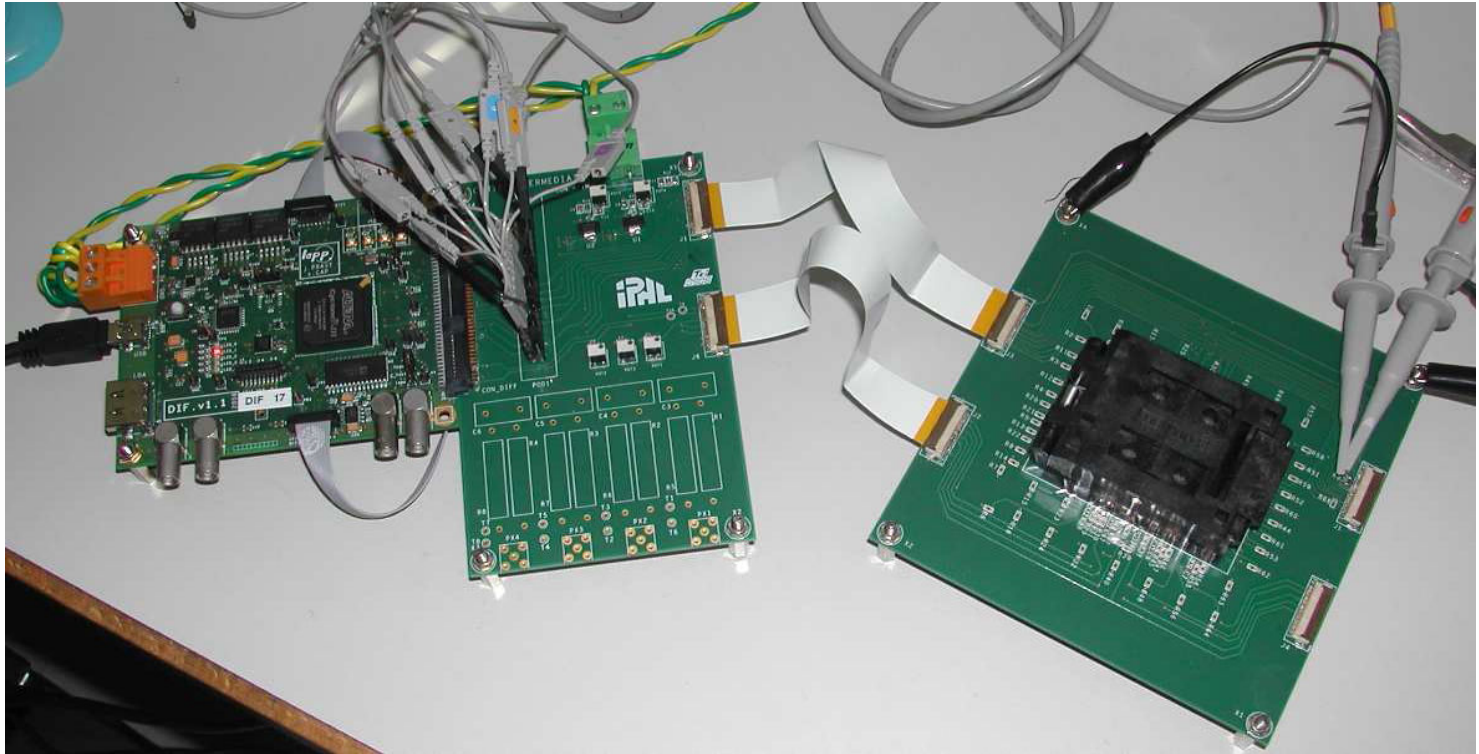
ASU 8x8 with DIRAC v.1

Dirac was initially developed at IPNL but now in tight collaboration with LAPP

First digital ASIC embedded on a bulk MICROMEAS: tested successfully in 2008 beam test



ASU 8x8 with DIRAC v.2



Setup for DIRAC v.2 ASU
DIRAC v.2 was fully characterized at LAPP

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D_{etector} I_{nter}F_{ace} developments

The DIF board is the first intermediate board between ASUs and DAQ

This DIF (see picture) has been developed at LAPP and has already been used in 2008 and 2009 for Eu-DHCAL MICROMEAS and RPC beam tests

This DIF is also compatible with ECAL and AHCAL detectors



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D_{etector} I_{nter}F_{ace} developments

Firmware already existing for :

HARDROCs 1

used by LAPP (MICROMEAS) and IPNL (RPC)

HARDROCs 2

used by LAPP (MICROMEAS) and soon IPNL (RPC)

DIRAC 2

used by LAPP (MICROMEAS)



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Conclusion

Developments of DHCAL readout and DAQ is in a good way :

→ DIF boards and VHDL firmware for different ASICs

→ Tests of various readout chips (Hardroc, Dirac)
Dirac optimized for MICROMEGAS

→ Work on a future CALICE DAQ
Should be ready in 2011